Welcome to [E-XFL.COM](#)**Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)**

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

**Applications of Embedded - CPLDs****Details**

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	128
Number of Gates	-
Number of I/O	120
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/m5lv-128-120-7yc">https://www.e-xfl.com/product-detail/lattice-semiconductor/m5lv-128-120-7yc</a>

Table 2. MACH 5 Speed Grades

Device	Speed Grade <sup>1</sup>						
	-5	-6	-7	-10	-12	-15	-20
M5-128 <sup>2</sup>			C	C, I	C, I	C, I	I
M5-128/1	C		C, I	C, I	C, I	C, I	I
M5LV-128	C		C,I	C, I	C, I	I	
M5-192/1	C		C, I	C, I	C, I	C, I	I
M5-256 <sup>2</sup>			C	C, I	C, I	C, I	I
M5-256/1	C		C, I	C, I	C, I	C, I	I
M5LV-256	C		C, I	C, I	C, I	I	
M5-320		C	C, I	C, I	C, I	C, I	I
M5LV-320		C	C, I	C, I	C, I	C, I	I
M5-384		C	C, I	C, I	C, I	C, I	I
M5LV-384		C	C, I	C, I	C, I	C, I	I
M5-512		C	C, I	C, I	C, I	C, I	I
M5LV-512		C	C, I	C, I	C, I	C, I	I

**Note:**

1. C = Commercial grade, I = Industrial grade
2. /1 version recommended for new designs

With Lattice's unique hierarchical architecture, the MACH 5 family provides densities up to 512 macrocells to support full system logic integration. Extensive routing resources ensure pinout retention as well as high utilization. It is ideal for PAL® block device integration and a wide range of other applications including high-speed computing, low-power applications, communications, and embedded control. At each macrocell density point, Lattice offers several I/O and package options to meet a wide range of design needs (Table 3).

Table 3. MACH 5 Package and I/O Options<sup>1</sup>

Supply Voltage	M5-128/1 M5LV-128		M5-256/1 M5LV-256		M5-320 M5LV-320		M5-384 M5LV-384		M5-512 M5LV-512		
	5	3.3	5	5	3.3	5	3.3	5	3.3	5	3.3
100-pin TQFP	68	68, 74	68	68	68*, 74						
100-pin PQFP	68	68*	68*	68*	68						
144-pin TQFP		104			104						
144-pin PQFP	104	104*	104*	104*	104*						
160-pin PQFP	120	120	120	120	120	120*	120	120*	120	120*	120
208-pin PQFP				160	160	160	160	160	160	160	160
240-pin PQFP						184*	184*	184*	184*	184*	184*
256-ball BGA						192	192*	192*	192*	192*	192*
352-ball BGA										256	256

**Note:**

1. The I/O options indicated with a "\*" are obsolete, please contact factory for more information.

Advanced power management options allow designers to incrementally reduce power while maintaining the level of performance needed for today's complex designs. I/O safety features allow for mixed-voltage design,

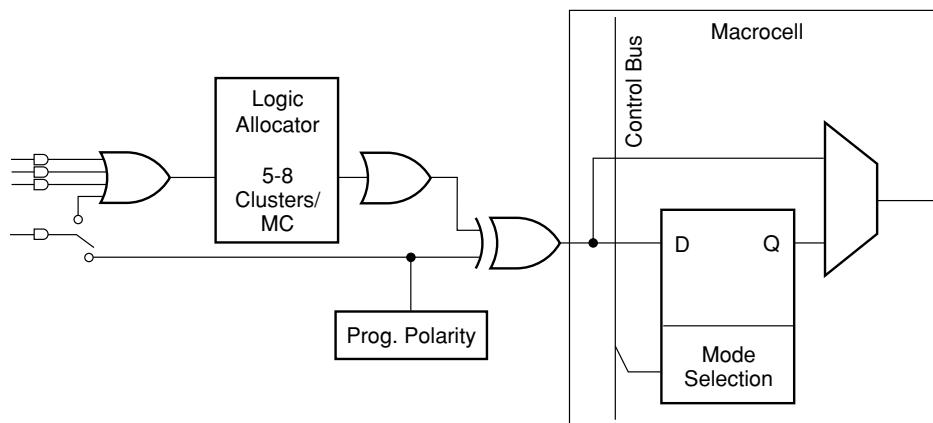
Select devices have been discontinued.  
See Ordering Information section for product status.

## Macrocells

The macrocells for MACH 5 devices consist of a storage element which can be configured for combinatorial, registered or latched operation (Figure 3). The D-type flip-flops can be configured as T-type, J-K, or S-R operation through the use of the XOR gate associated with each macrocell.

Each PAL block has the capability to provide two input registers by using macrocells 0 and 15. In order to use this option, these macrocells must be accessed via the I/O pins associated with macrocells 3 and 12, respectively. Once the macrocell is used as an input register, it cannot be used for logic, so its clusters can be re-directed through the logic allocator to another macrocell. The

I/O pins associated with macrocells 0 and 15 can still be used as input pins. Although the I/O pins for macrocells 3 and 12 are used to connect to the input registers, these macrocells can still be used as “buried” macrocells to drive device logic via the matrix.



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**Figure 3. Macrocell Diagram**

## Control Generator

The control generator provides four configurable clock lines and three configurable set/reset lines to each macrocell in a PAL block. Any of the four clock lines and any of the three set/reset lines can be independently selected by any flip-flop within a block. The clock lines can be configured to provide synchronous global (pin) clocks and asynchronous product term clocks, sum term clocks, and latch enables (Figure 4). Three of the four global clocks, as well as two product-term clocks and one sum-term clock, are available per PAL block. Positive or negative edge clocking is available as well as advanced clocking features such as **complementary** and **biphase** clocking. Complementary clocking provides two clock lines exactly 180 degrees out of phase, and is useful in applications such as fast data paths. A biphase clock line clocks flip-flops on both the positive and negative edges of the clock. The configuration options for the four clock lines per PAL block are as follows:

### Clock Line 0 Options

- ◆ Global clock (0, 1, 2, or 3) with positive or negative edge clock enable
- ◆ Product-term clock ( $A^*B^*C$ )
- ◆ Sum-term clock ( $A+B+C$ )

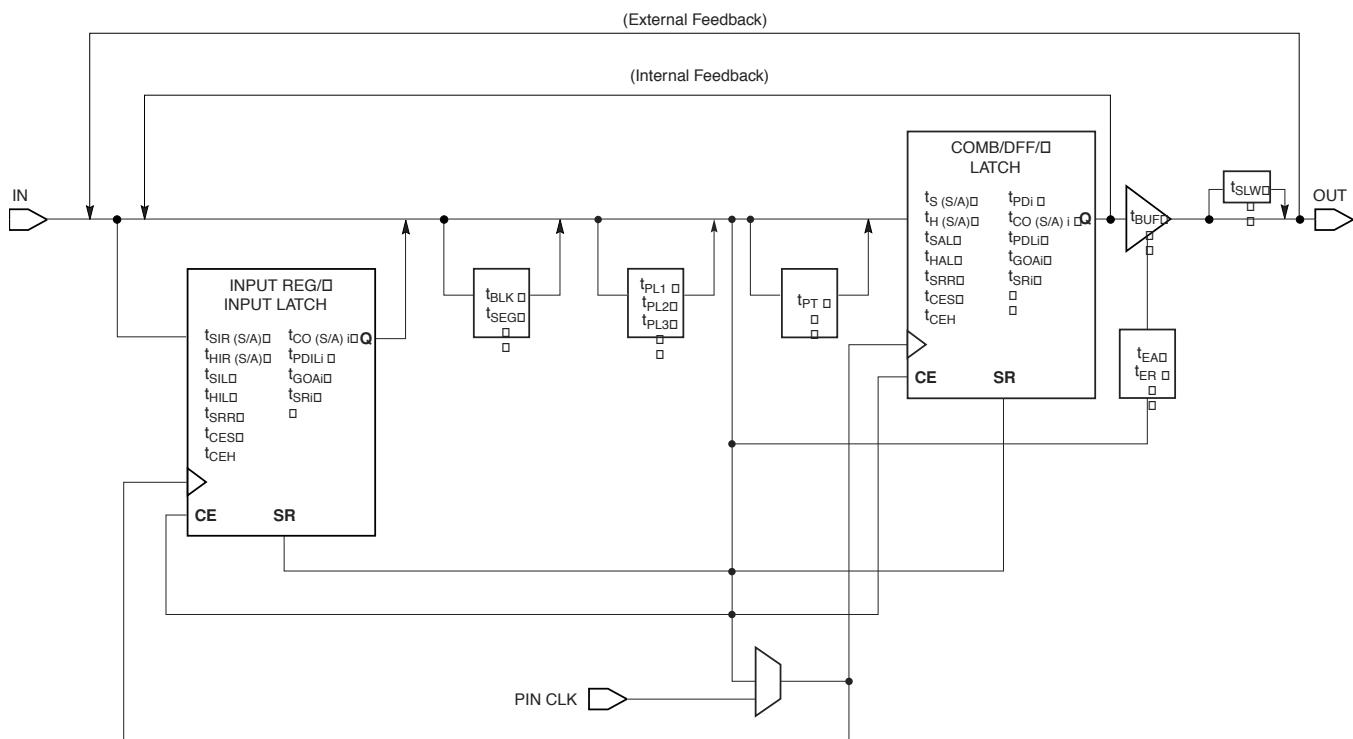
### Clock Line 1 Options

- ◆ Global clock (0, 1, 2, or 3) with positive edge clock enable
- ◆ Global clock (0, 1, 2, or 3) with negative edge clock enable

## MACH 5 TIMING MODEL

The primary focus of the MACH 5 timing model is to accurately represent the timing in a MACH 5 device, and at the same time, be easy to understand. This model accurately describes all combinatorial and registered paths through the device, making a distinction between **internal feedback** and **external feedback**. A signal uses internal feedback when it is fed back into the switch matrix or block without having to go through the output buffer. The input register specifications are also reported as internal feedback. When a signal is fed back into the switch matrix after having gone through the output buffer, it is using external feedback.

The parameter,  $t_{BUF}$  is defined as the time it takes to go through the output buffer to the I/O pad. If a signal goes to the internal feedback rather than to the I/O pad, the parameter designator is followed by an “i”. By adding  $t_{BUF}$  to this internal parameter, the external parameter is derived. For example,  $t_{PD} = t_{PDI} + t_{BUF}$ . A diagram representing the modularized MACH 5 timing model is shown in Figure 7. Refer to the Technical Note entitled *MACH 5 Timing and High Speed Design* for a more detailed discussion about the timing parameters.



**Figure 7. MACH 5 Timing Model**

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**See Ordering Information section for product status.**

Select devices have been discontinued.

## MULTIPLE I/O AND DENSITY OPTIONS

The MACH 5 family offers six macrocell densities in a number of I/O options. This allows designers to choose a device close to their logic density and I/O requirements, thus minimizing costs. For the same package type, every density has the same pin-out. With proper design considerations, a design can be moved to a higher or lower density part as required.

## IEEE 1149.1 - COMPLIANT BOUNDARY SCAN TESTABILITY

Most MACH 5 devices have boundary scan registers and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more complete board-level testing.

## IEEE 1149.1 - COMPLIANT IN-SYSTEM PROGRAMMING

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality, and the ability to make in-field modifications. All MACH 5 devices provide in-system programming (ISP) capability through their IEEE 1149.1-compliant Boundary Scan Test Access Port. By using the IEEE 1149.1-compliant Boundary Scan Test Access Port as the communication interface through which ISP is achieved, customers get the benefit of a standard, well-defined interface.

MACH 5 devices can be programmed across the commercial temperature and voltage range. The PC-based LatticePRO software facilitates in-system programming of MACH 5 devices. LatticePRO software takes the JEDEC file output produced by design implementation software, along with information about the Boundary Scan chain, and creates a set of vectors that are used to drive the Boundary Scan chain. LatticePRO software can use these vectors to drive a Boundary Scan chain via the parallel port of a PC. Alternatively, LatticePRO software can output files in formats understood by common automated test equipment. This equipment can then be used to program MACH 5 devices during the testing of a circuit board.

## PCI COMPLIANT

MACH 5 devices in the -5/-6/-7/-10/-12 speed grades are compliant with the *PCI Local Bus Specification* version 2.1, published by the PCI Special Interest Group (SIG). The 5-V devices are fully PCI-compliant. The 3.3-V devices are mostly compliant but do not meet the PCI condition to clamp the inputs as they rise above V<sub>CC</sub> because of their 5-V input tolerant feature. MACH 5 devices provide the speed, drive, density, output enables and I/Os for the most complex PCI designs.

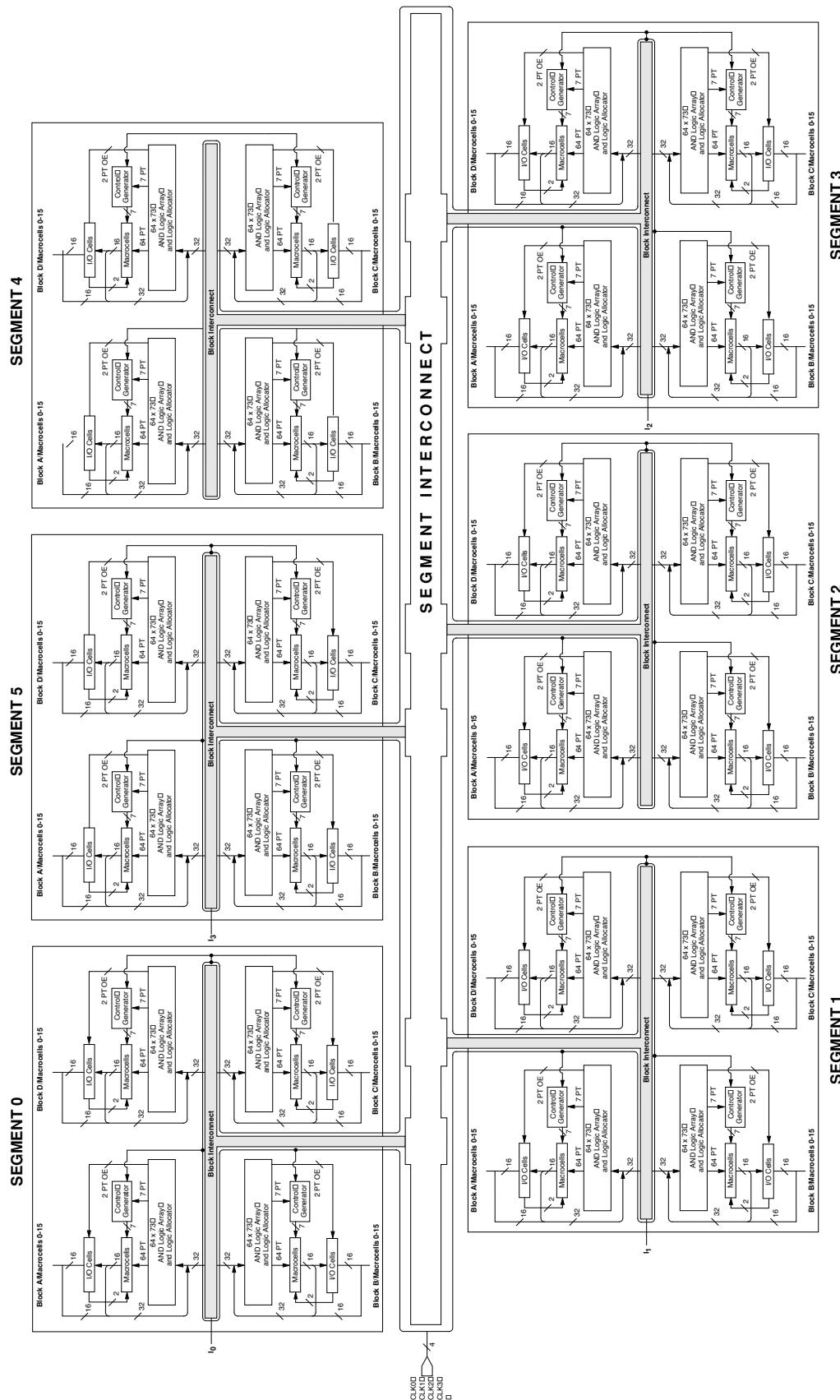
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## **SECURITY BIT**

A programmable security bit is provided on the MACH 5 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

**Select devices have been discontinued.**  
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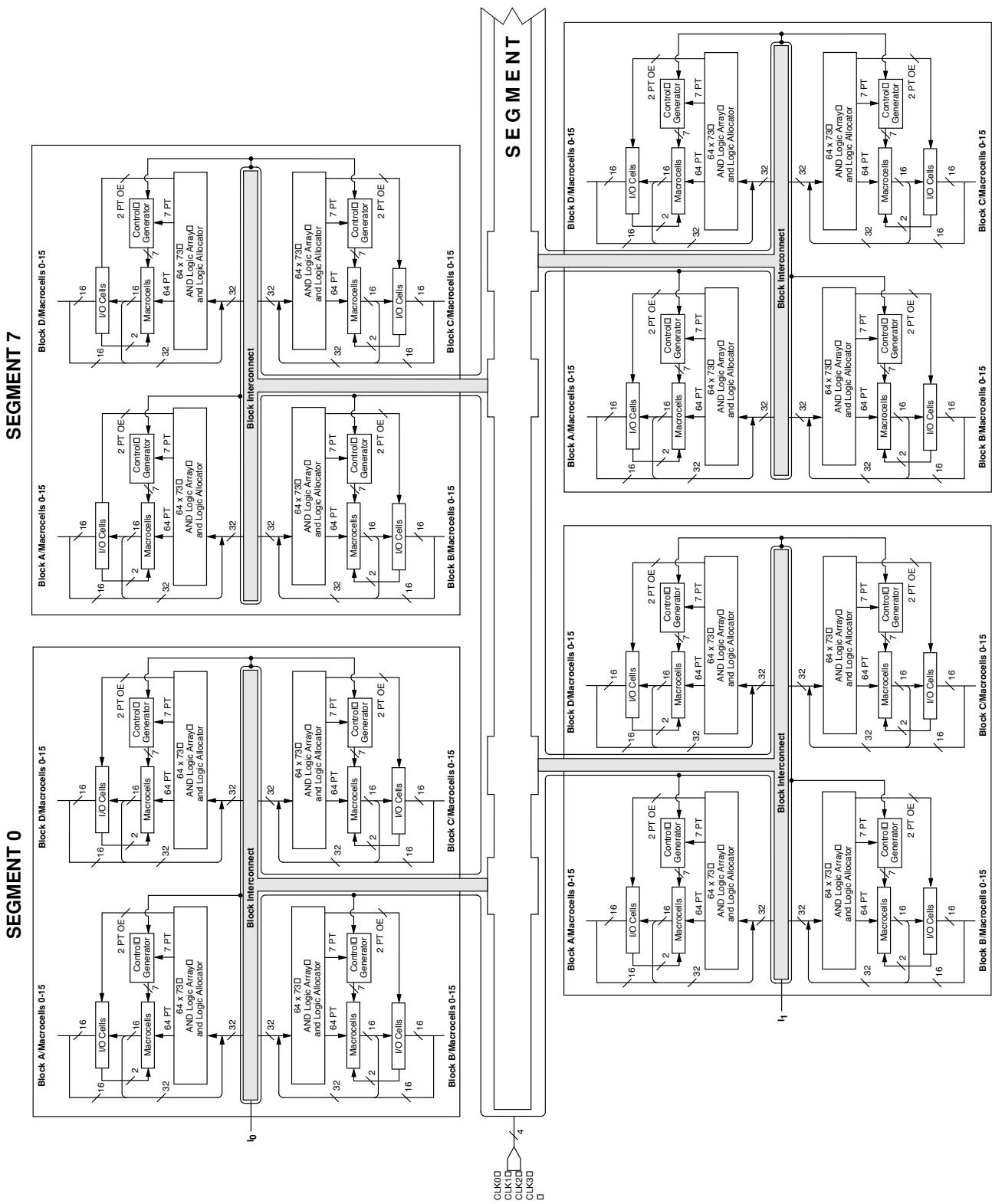
## BLOCK DIAGRAM — M5(LV)-384/XXX



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# BLOCK DIAGRAM — M5(LV)-512/XXX

## **Continued**



**Select devices have been discontinued.  
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Select devices have been discontinued.  
See Ordering Information section for product status.

## ABSOLUTE MAXIMUM RATINGS

### M5

Storage Temperature.....	-65°C to +150°C
Device Junction Temperature (Note 1).....	+130°C or +150°C
Supply Voltage with Respect to Ground .....	-0.5 V to +7.0 V
DC Input Voltage .....	-0.5 V to 5.5 V
Static Discharge Voltage.....	2000 V
Latchup Current (-40°C to +85°C) .....	200 mA
<i>Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.</i>	

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ )	
Operating in Free Air.....	0°C to +70°C
Supply Voltage ( $V_{CC}$ ) with Respect to Ground.....	+4.75 V to +5.25 V

### Industrial (I) Devices

Ambient Temperature ( $T_A$ )	
Operating in Free Air.....	-40°C to +85°C
Supply Voltage ( $V_{CC}$ ) with Respect to Ground.....	+4.5 V to +5.5 V
<i>Operating ranges define those limits between which the functionality of the device is guaranteed.</i>	

## 5-V DC CHARACTERISTICS OVER OPERATING RANGES

Parameter Symbol	Parameter Description	Test Description	Min	Typ	Max	Unit
$V_{OH}$	Output HIGH Voltage (For M5-128/1, M5-192/1, M5-256/1, M5-320, M5-384, M5-512 Devices)	$I_{OH} = -3.2 \text{ mA}, V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	2.4			V
		$I_{OH} = -100 \mu\text{A}, V_{CC} = \text{Max}, V_{IN} = V_{IH} \text{ or } V_{IL}$		3.3	3.6	V
	Output HIGH Voltage (For M5-128, M5-192, M5-256 Devices)	$I_{OH} = -3.2 \text{ mA}, V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	2.4			V
		$I_{OH} = -2.5 \text{ mA}, V_{CC} = 5.25 \text{ V}, V_{IN} = V_{IH} \text{ or } V_{IL}$			3.6	V
$V_{OL}$	Output LOW Voltage (Note 2)	$I_{OL} = +16 \text{ mA}, V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$			0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 3)	2.0			V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 3)			0.8	V
$I_{IH}$	Input HIGH Leakage Current	$V_{IN} = 5.25, V_{CC} = \text{Max}$ (Note 4)			10	$\mu\text{A}$
$I_{IL}$	Input LOW Leakage Current	$V_{IN} = 0, V_{CC} = \text{Max}$ (Note 4)			-10	$\mu\text{A}$
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 5.25, V_{CC} = \text{Max}, V_{IN} = V_{IH} \text{ or } V_{IL}$ (Note 4)			10	$\mu\text{A}$
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0, V_{CC} = \text{Max}, V_{IN} = V_{IH} \text{ or } V_{IL}$ (Note 4)			-10	$\mu\text{A}$
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5 \text{ V}, V_{CC} = \text{Max}, V_{IN} = V_{IH} \text{ or } V_{IL}$ (Note 5)	-30		-180	mA

#### Note:

- 150° for M5-128, M5-192 and M5-256 devices. 130° for M5-128/1, M5-192/1, M5-256/1, M5-320, M5-384 and M5-512 devices.
- Total  $I_{OL}$  between ground pins should not exceed 64 mA.
- These are absolute values with respect to device ground, and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  or  $I_{IH}$  and  $I_{OZH}$ .
- Not more than one output should be shorted at a time. Duration of the short-circuit should not exceed one second.

See Ordering Information section for product status.

## M5(LV) TIMING PARAMETERS OVER OPERATING RANGES<sup>1</sup> (CONTINUED)

	-5		-6		-7		-10		-12		-15		-20		Unit	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
<b>Power Delays:</b>																
t <sub>PL1</sub>	Power level 1 delay (Note 2)		4.0 (5.0)		4.0		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)	ns
t <sub>PL2</sub>	Power level 2 delay (Note 2)		6.0 (9.0)		6.0		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)	ns
t <sub>PL3</sub>	Power level 3 delay (Note 2)		9.0 (17.5)		9.0		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)	ns
<b>Additional Cluster Delay:</b>																
t <sub>PT</sub>	Product term cluster delay		0.3		0.3		0.3		0.3		0.3		0.3		0.3	ns
<b>Interconnect Delays:</b>																
t <sub>BLK</sub>	Block interconnect delay		1.5		1.5		1.5		2.0		2.0		2.0		2.0	ns
t <sub>SEG</sub>	Segment interconnect delay		4.5		4.5		5.0		6.0		6.0		6.0		6.0	ns
<b>Reset and Preset Delays:</b>																
t <sub>SRI</sub>	Asynchronous reset or preset to internal register output		6.0		8.0		8.0		10.0		12.0		14.0		16.0	ns
t <sub>SR</sub>	Asynchronous reset or preset to register output		8.0		10.0		10.0		12.0		14.0		16.0		18.0	ns
t <sub>SRR</sub>	Reset and set register recovery time	5.5		7.5		7.5		8.0		9.0		10.0		11.0		ns
t <sub>SRW</sub>	Asynchronous reset or preset width	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
<b>Clock Enable Delays:</b>																
t <sub>CES</sub>	Clock enable setup time	4.0		5.0		5.0		6.0		7.0		7.0		8.0		ns
t <sub>CEH</sub>	Clock enable hold time	3.0		4.0		4.0		5.0		6.0		6.0		7.0		ns
<b>Width:</b>																
t <sub>WLS</sub>	Global clock width low (Note 3)	2.5		3.0		3.0		4.0		5.0		6.0		6.0		ns
t <sub>WHS</sub>	Global clock width high (Note 3)	2.5		3.0		3.0		4.0		5.0		6.0		6.0		ns
t <sub>WLA</sub>	Product term clock width low	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>WHA</sub>	Product term clock width high	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>GWA</sub>	Gate width low (for low transparent) or high (for high transparent)	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>WIR</sub>	Input register clock width low or high	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns

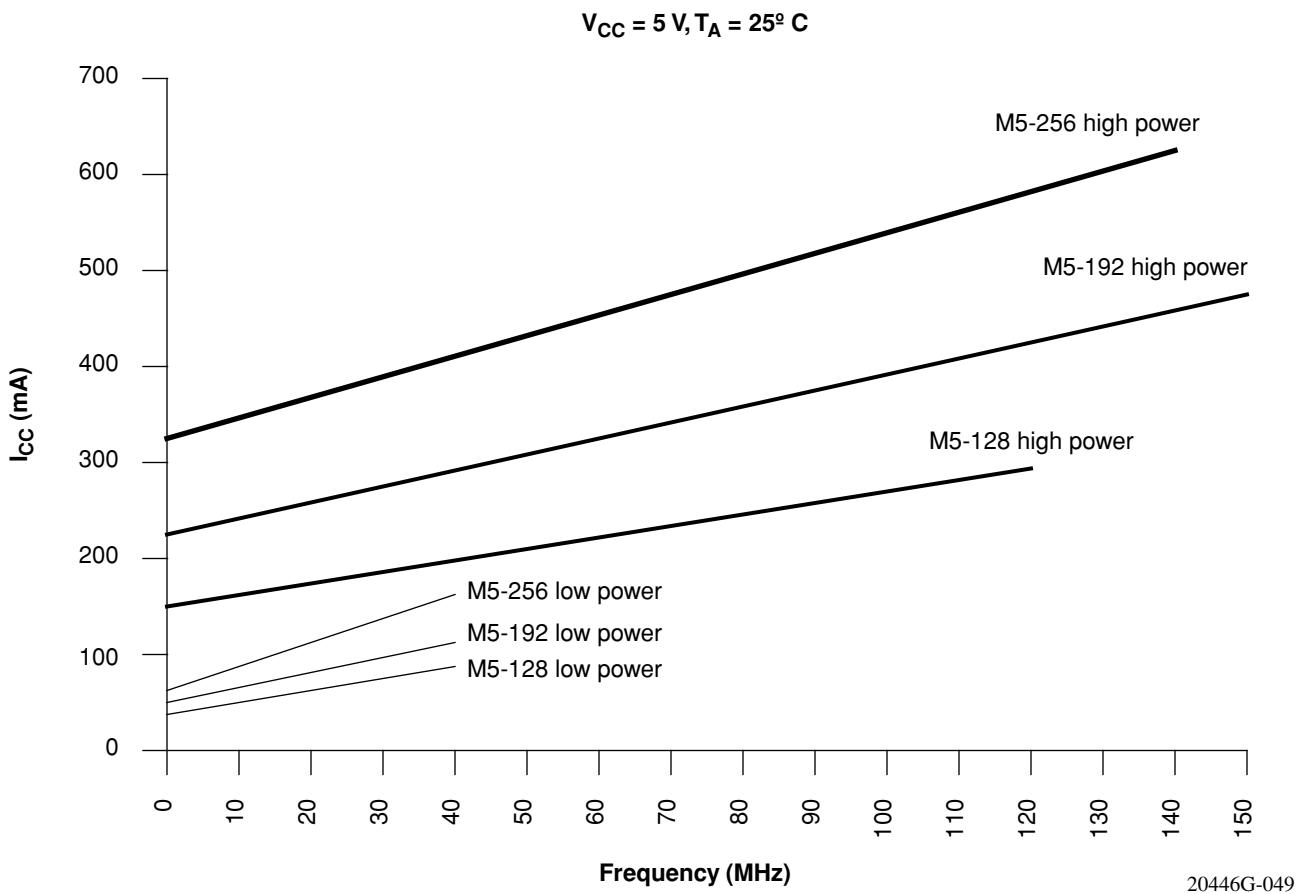
## M5(LV) TIMING PARAMETERS OVER OPERATING RANGES<sup>1</sup> (CONTINUED)

	-5		-6		-7		-10		-12		-15		-20		Unit	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
<b>Frequency:</b>																
$f_{MAX}$	External feedback, PAL block level. Min of $1/(t_{WLS} + t_{WHS})$ or $1/(t_{SS} + t_{COS})$	133		125		100		83.3		71.4		55.6		45.5		MHz
	Internal feedback, PAL block level. Min of $1/(t_{WLS} + t_{WHS})$ or $1/(t_{SS} + t_{COSi})$	182		167		125		100		83.3		62.5		50.0		MHz
	No feedback PAL block level. Min of $1/(t_{WLS} + t_{WHS})$ or $1/(t_{SS} + t_{HS})$	200		167		167		125		100		83.3		83.3		MHz
$f_{MAXA}$	External feedback, PAL block level. Min of $1/(t_{WLA} + t_{WHA})$ or $1/(t_{SA} + t_{COA})$	91		91		71.4		58.8		47.6		41.7		35.7		MHz
	Internal feedback, PAL block level. Min of $1/(t_{WLA} + t_{WHA})$ or $1/(t_{SA} + t_{COAi})$	111		111		83.3		66.7		52.6		45.5		38.5		MHz
	No feedback, PAL block level. Min of $1/(t_{WLA} + t_{WHA})$ or $1/(t_{SA} + t_{HA})$	167		125		125		100		83.3		71.4		62.5		MHz
$f_{MAXI}$	Maximum input register frequency $1/(t_{SIRS} + t_{HIRS})$ or $1/(2 \times t_{WICW})$	167		125		125		100		83.3		71.4		62.5		MHz

**Notes:**

1. See "MACH Switching Test Circuits" documentation on the Lattice Data Book CD-ROM or Lattice web site.
2. Numbers in parentheses are for M5-128, M5-192, M5-256.
3. If a signal is used as both a clock and a logic array input, then the maximum input frequency applies ( $f_{MAX}/2$ ).

Select devices have been discontinued.  
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**Figure 9.  $I_{CC}$  Curves at High/Low Power Modes**

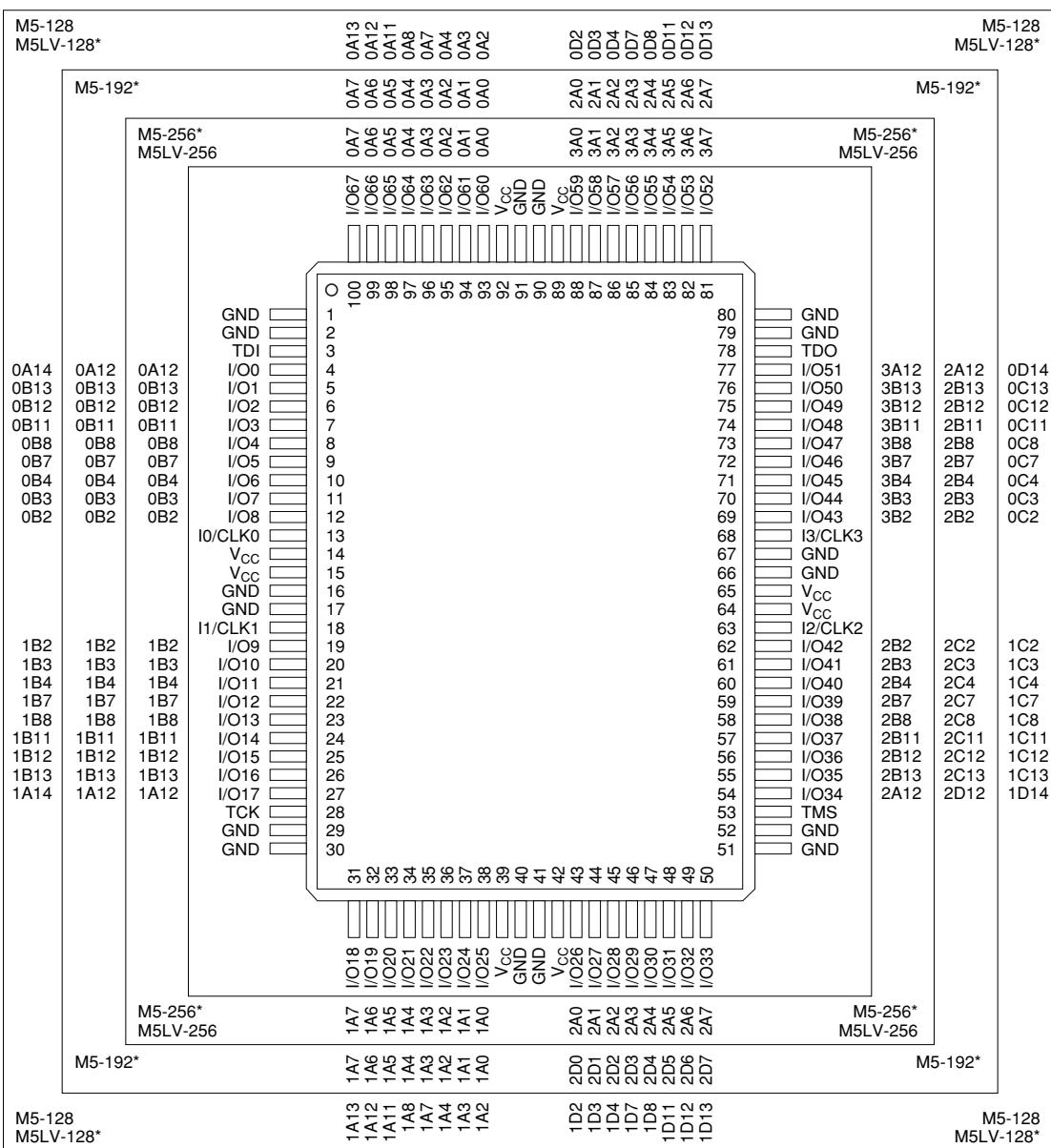
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**See Ordering Information section for product status.**

## 100-PIN PQFP CONNECTION DIAGRAM

### Top View

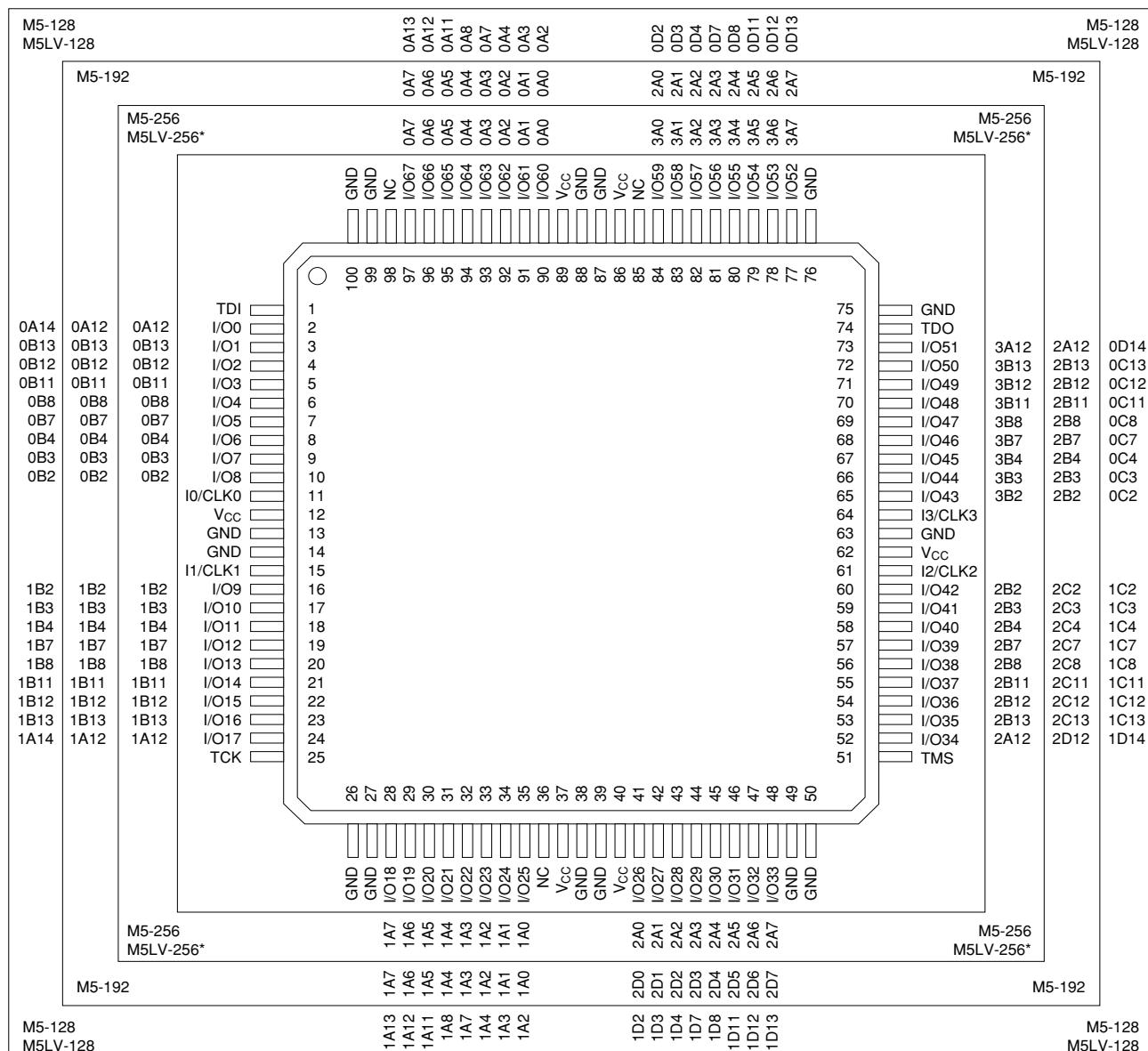
100-Pin PQFP (68 I/O)



## 100-PIN TQFP CONNECTION DIAGRAM – 68 I/O

### Top View

100-Pin TQFP (68 I/O)



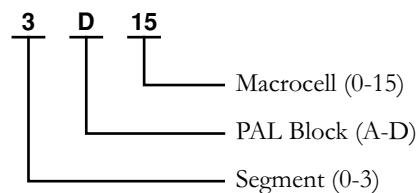
\*Package obsolete, contact factory.

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### Pin Designations

CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out

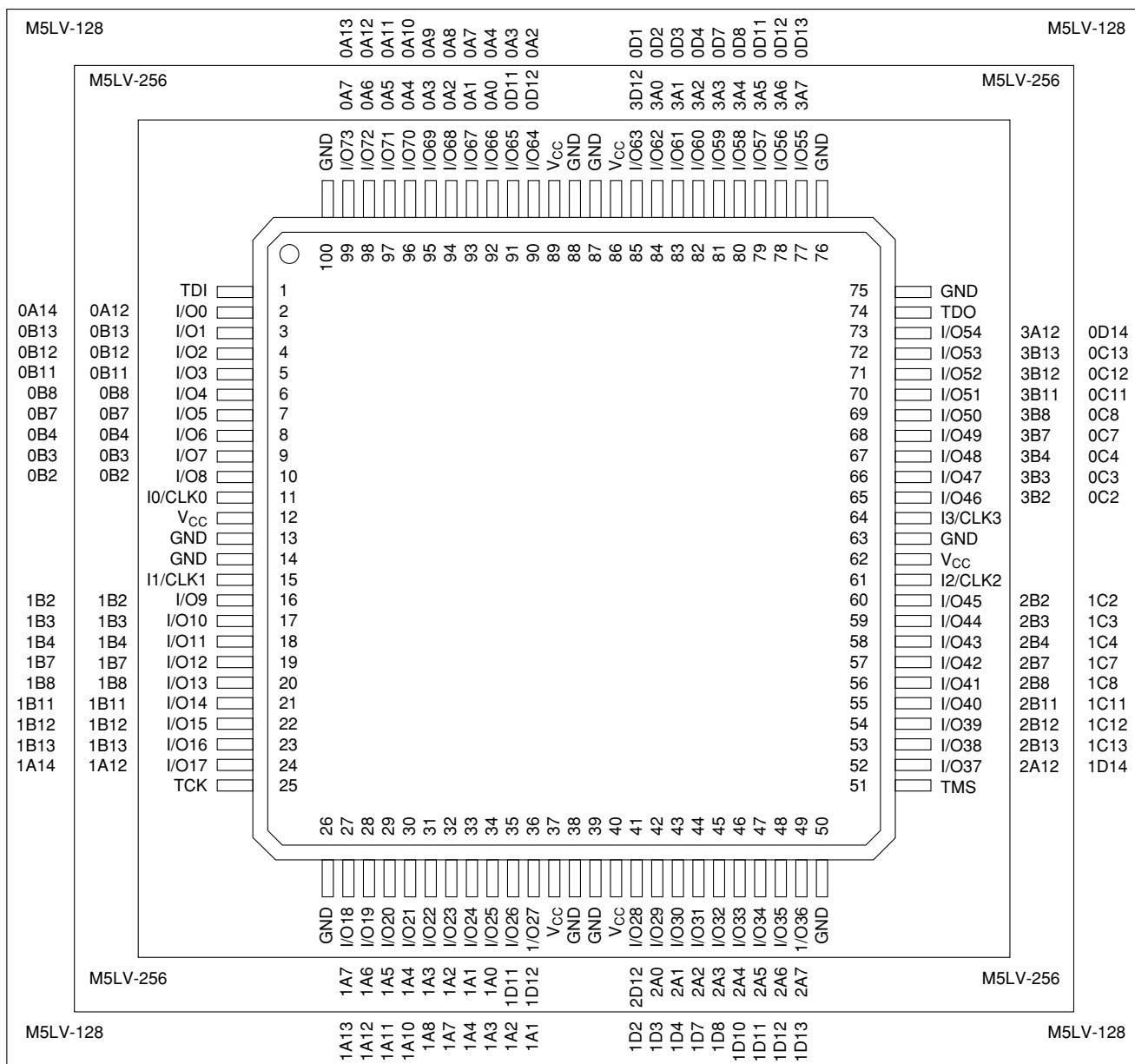


**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## 100-PIN TQFP CONNECTION DIAGRAM – 74 I/O

### Top View

100-Pin TQFP (74 I/O)

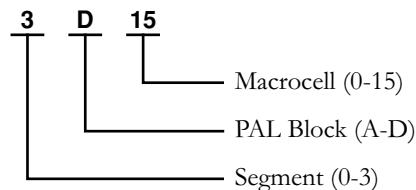


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### Pin Designations

CLK	= Clock
GND	= Ground
I	= Input
I/O	= Input/Output
NC	= No Connect

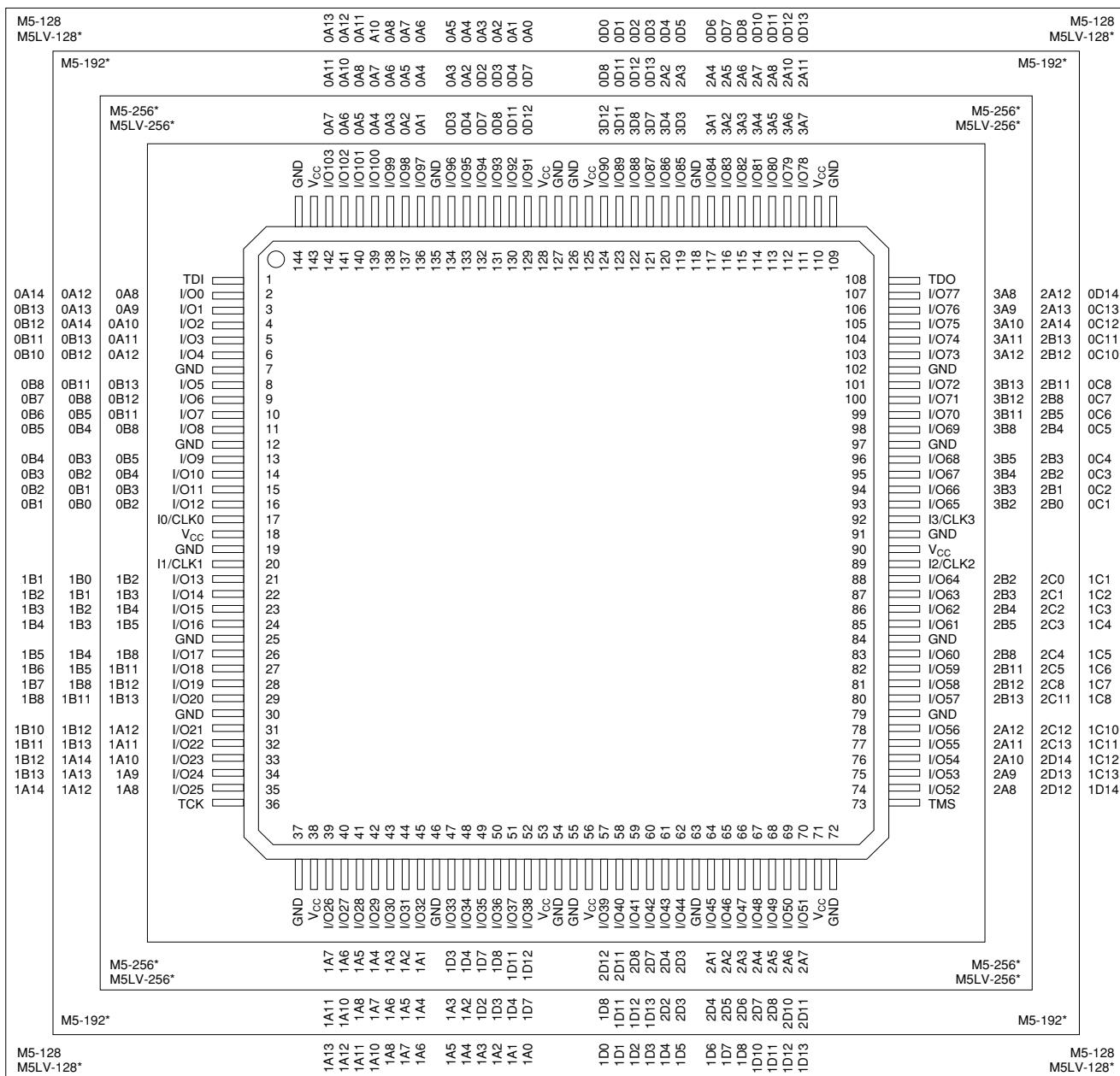
V <sub>CC</sub>	= Supply Voltage
TDI	= Test Data In
TCK	= Test Clock
TMS	= Test Mode Select
TDO	= Test Data Out



## 144-PIN PQFP CONNECTION DIAGRAM

Top View

144-Pin PQFP



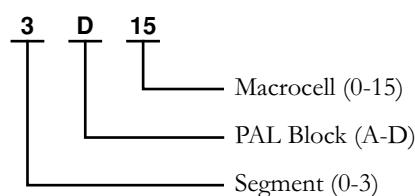
\*Package obsolete, contact factory.

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**Select devices have been discontinued.  
See Ordering Information section for product status.**

### Pin Designations

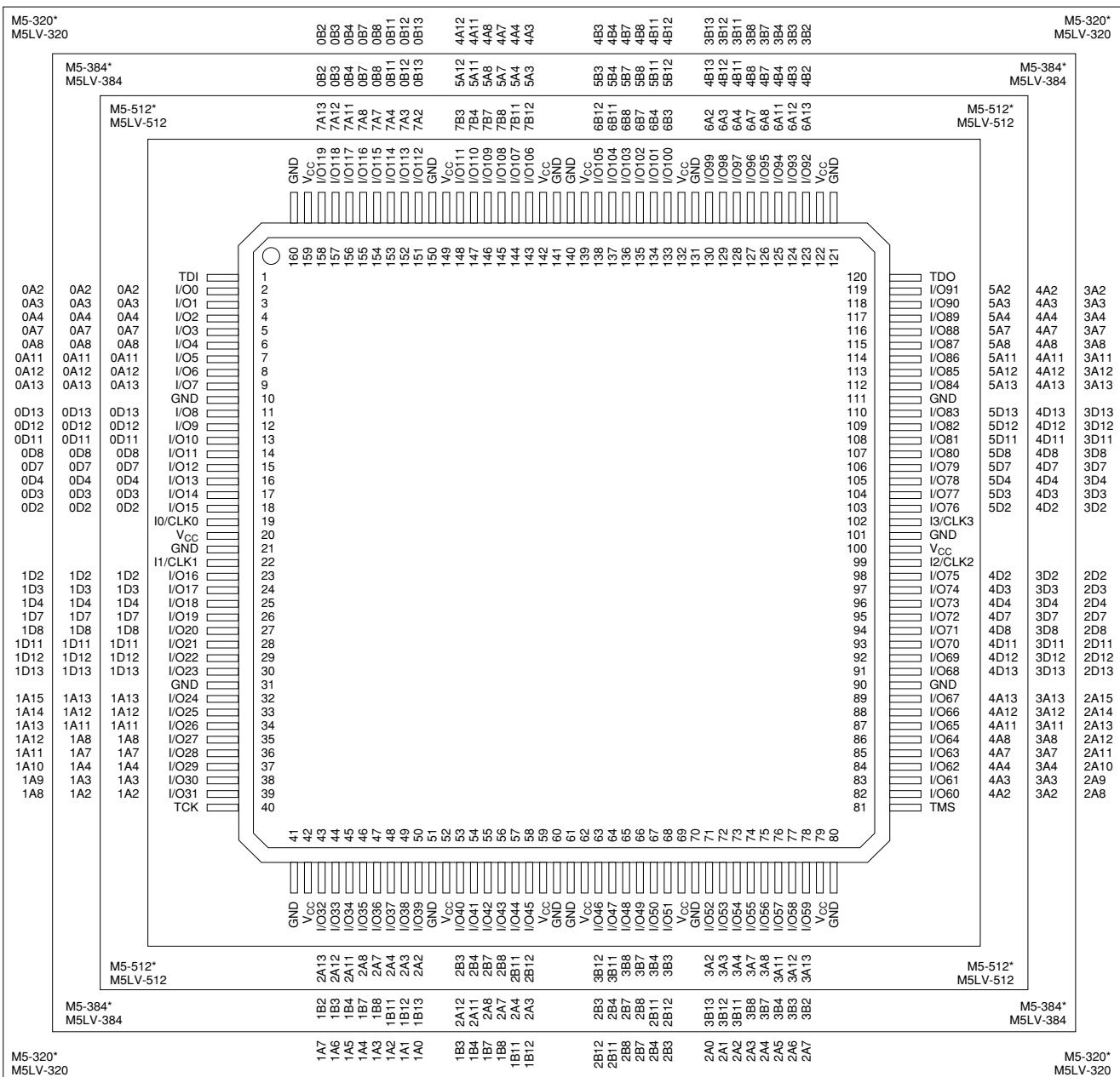
CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out



**Select devices have been discontinued.**  
See Ordering Information section for product status.

## 160-PIN PQFP (WITH INTERNAL HEAT SPREADER) CONNECTION DIAGRAM Top View

160-Pin PQFP (320, 384, 512 Macrocells)

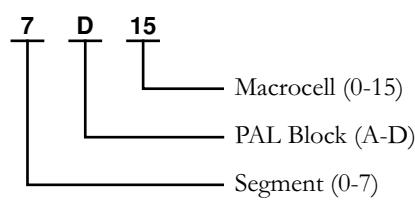


\*Package obsolete, contact factory.

20446G-022

### Pin Designations

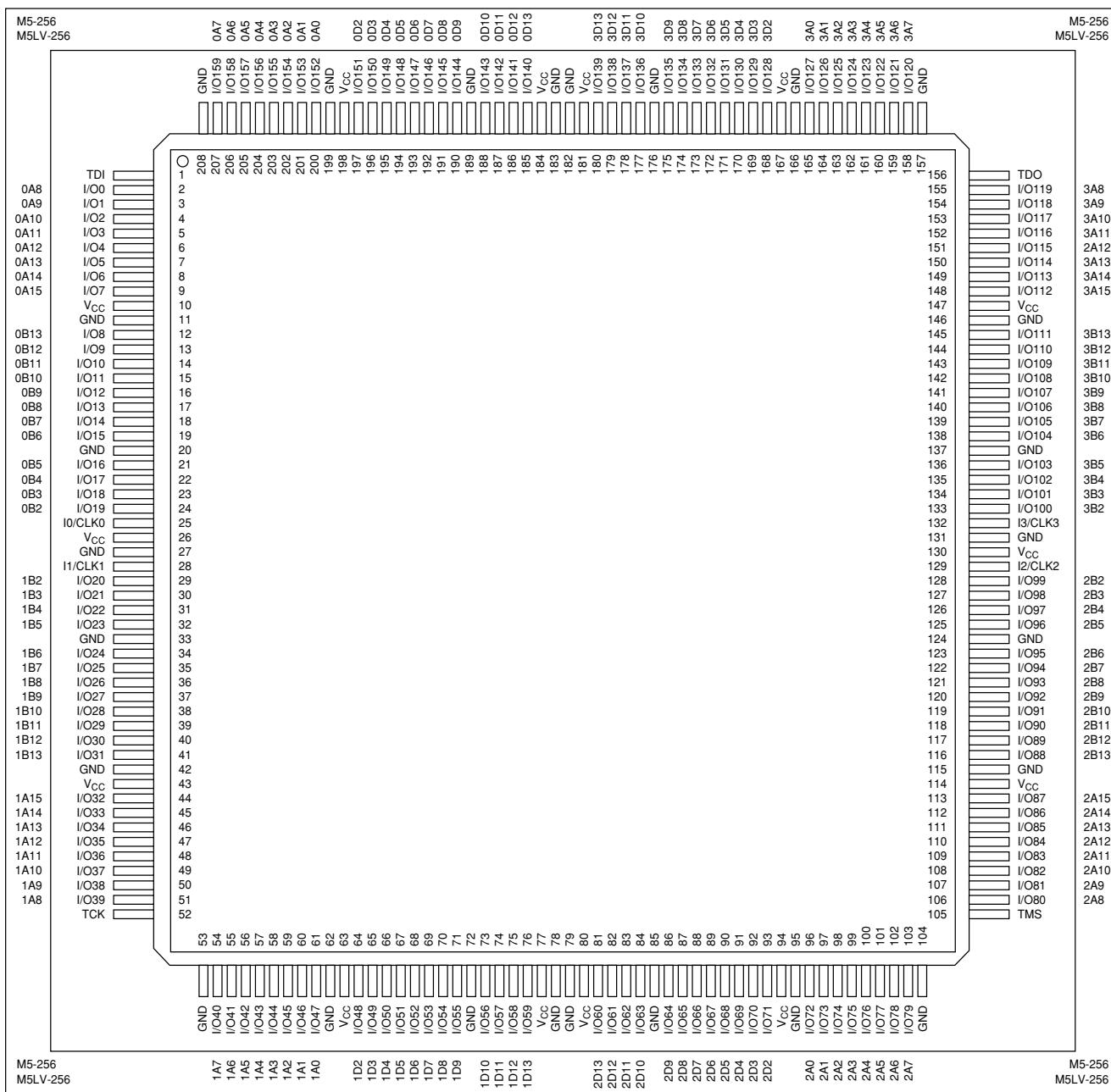
CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out



## 208-PIN PQFP CONNECTION DIAGRAM

### Top View

208-Pin PQFP (256 Macrocells)

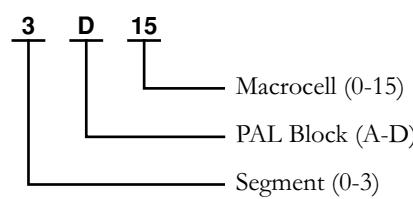


20446G-023

**Select devices have been discontinued.**  
See Ordering Information section for product status.

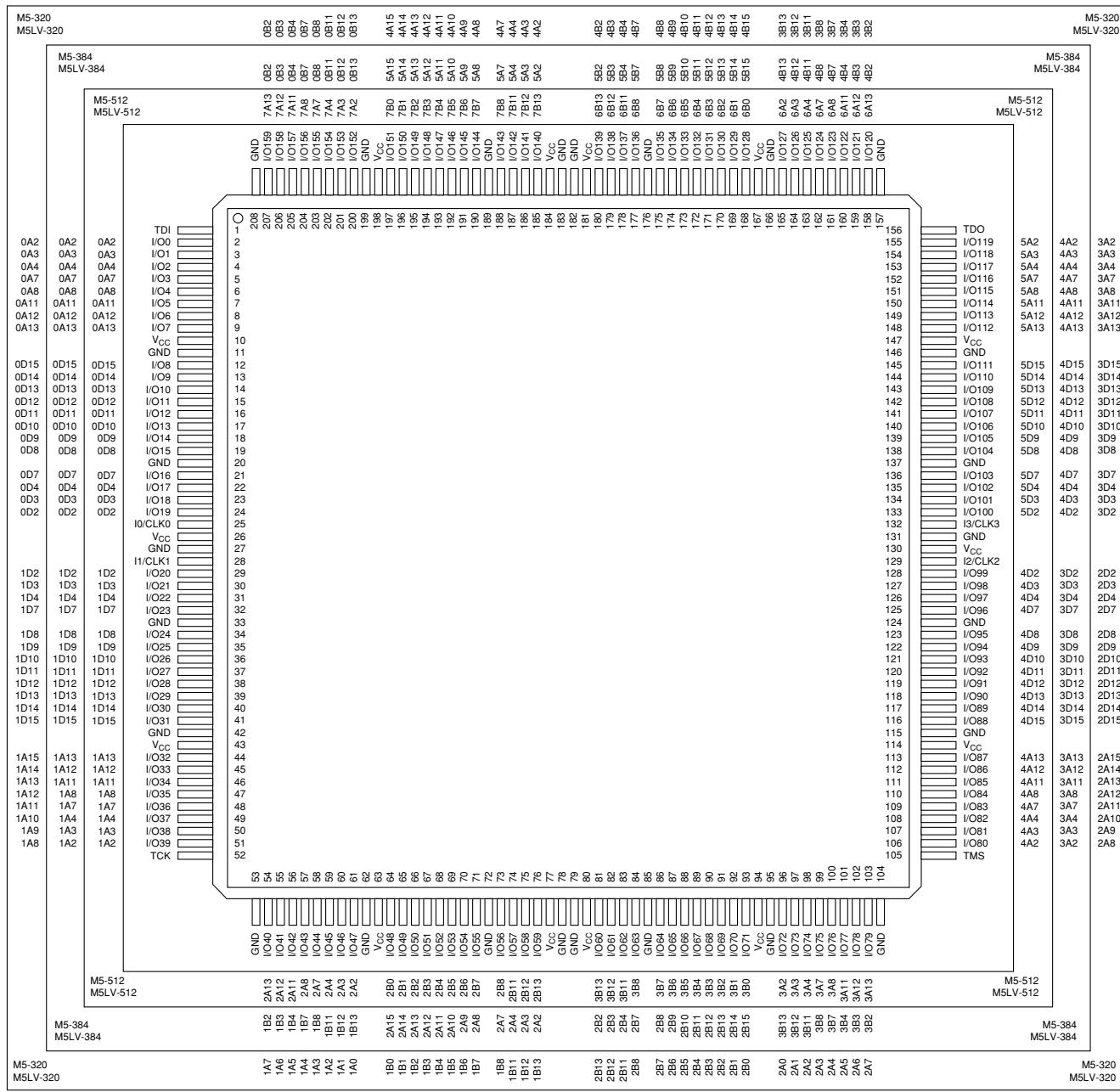
### Pin Designations

CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out



## **208-PIN PQFP (WITH INTERNAL HEAT SPREADER) CONNECTION DIAGRAM**

## **208-Pin PQFP (320, 384, 512 Macrocells)**



**Select devices have been discontinued.**  
**See Ordering Information section for product status**

## Pin Designations

CLK = Clock

GND = Ground

I = Input

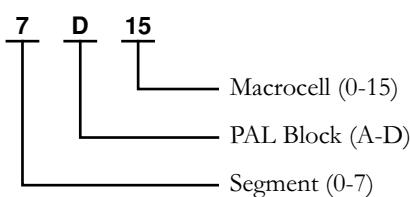
I/O = Input/Output

$V_{CC}$  = Supply Voltage

TDI = Test Data In

TCK = Test Clock

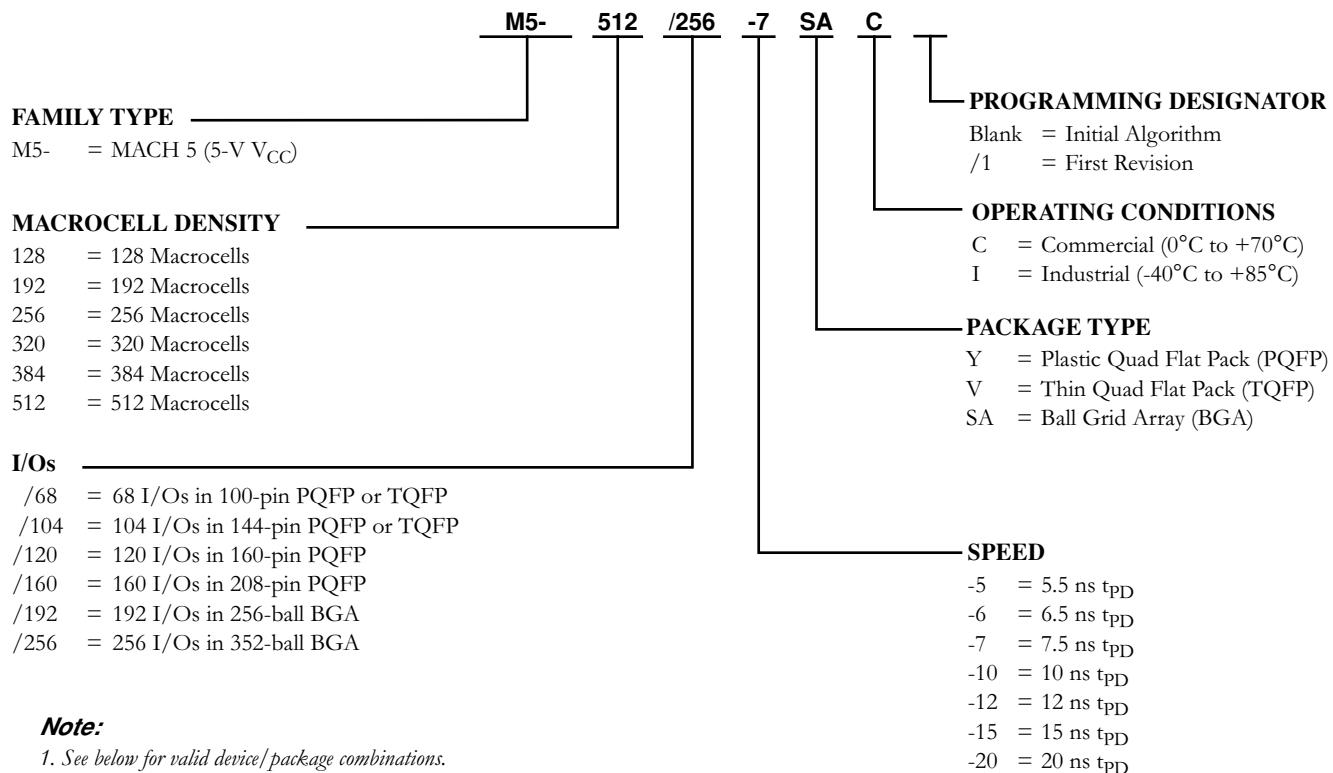
TMS = Test Mode Select



Select devices have been discontinued.  
See Ordering Information section for product status.

## 5V M5 ORDERING INFORMATION<sup>1,2</sup>

Lattice standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.



**Note:**

1. See below for valid device/package combinations.
2. M5-128/1, M5-192/1 and M5-256/1 recommended for new designs.

Valid Combinations		
M5-128/68		YC, VC, YI, VI
M5-128/104		YC <sup>1</sup> , YI <sup>1</sup>
M5-128/120	Commercial:	YC, YI
M5-192/68	-5, -7, -10, -12, -15	VC, VI
M5-192/120	Industrial:	YC, YI
M5-256/68	-7, -10, -12, -15, -20	VC, VI
M5-256/120		YC, YI
M5-256/160		YC, YI

### Device Marking

Actual device marking differs from the ordering part number (OPN). All MACH devices are dual-marked with both Commercial and Industrial grades. The Industrial grade is slower, i.e., M5-512/256-7AC-10AI.

1. M5-128/104-xxYC/1 and M5-128/104-xxYI/1 have been discontinued per PCN #06-07. Contact Rochester Electronics for available inventory.

Valid Combinations		
M5-320/160	Commercial:	YC, YI
M5-320/192		SAC, SAI
M5-384/160	-6, -7, -10, -12, -15	YC, YI
M5-512/160	Industrial:	YC, YI
M5-512/256	-7, -10, -12, -15, -20	SAC, SAI

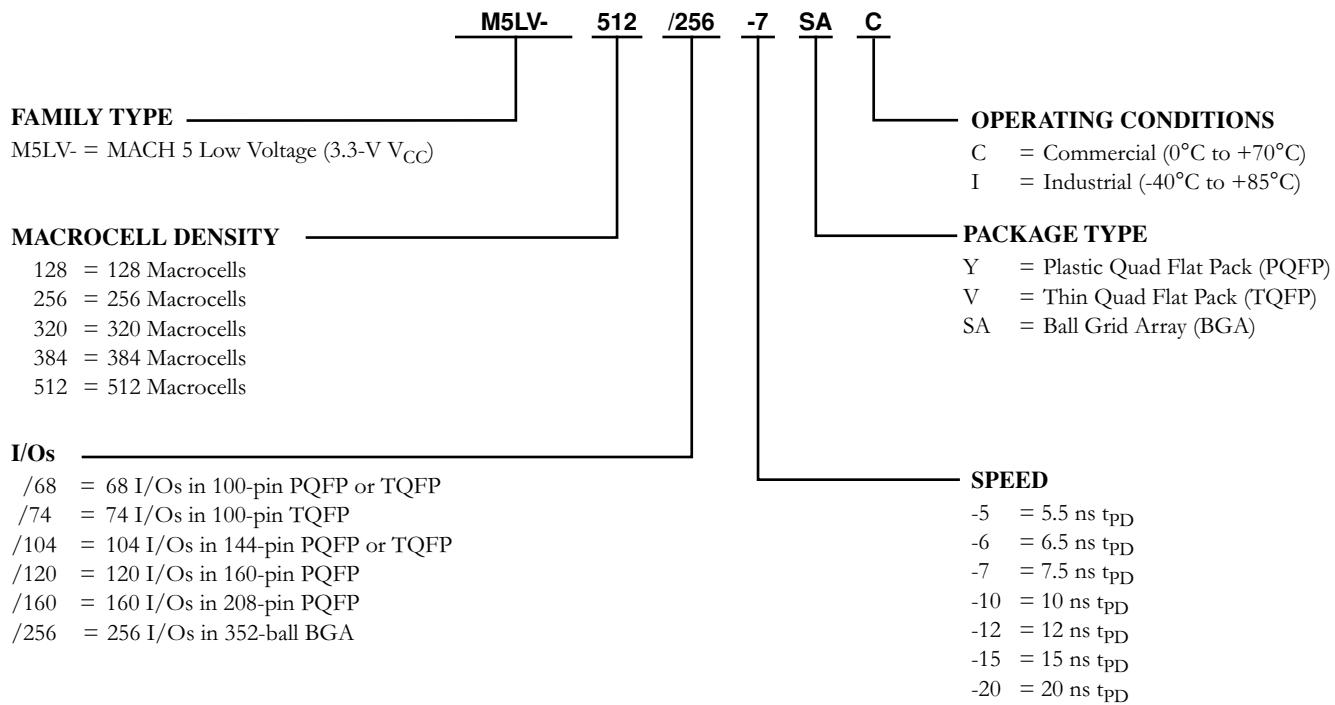
### Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local Lattice sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Select devices have been discontinued.  
See Ordering Information section for product status.

## 3.3V M5LV ORDERING INFORMATION<sup>1</sup>

Lattice standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.



**Note:**

1. See below for valid device/package combinations.

Valid Combinations		
M5LV-128/68		VC, VI
M5LV-128/74		VC, VI
M5LV-128/104		VC, VI
M5LV-128/120	Commercial: -5, -7, -10, -12	YC, YI
M5LV-256/68		YC, YI
M5LV-256/74	Industrial: -7, -10, -12, -15	VC, VI
M5LV-256/104		VC, VI
M5LV-256/120		YC, YI
M5LV-256/160		YC, YI

### Device Marking

Actual device marking differs from the ordering part number (OPN). All MACH devices are dual-marked with both Commercial and Industrial grades. The Industrial grade is slower, i.e., M5LV-512/256-7AC-10AI.

Valid Combinations		
M5LV-320/120		YC, YI
M5LV-320/160	Commercial: -6, -7, -10, -12, -15	YC, YI
M5LV-384/120		YC, YI
M5LV-384/160		YC, YI
M5LV-512/120	Industrial: -10, -12, -15, -20	YC, YI
M5LV-512/160		YC, YI
M5LV-512/256		SAC, SAI

### Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local Lattice sales office to confirm availability of specific valid combinations and to check on newly released combinations.